## **BGA Heat Sink - High Performance** maxiFLOW w/Thermal Tape





ATS Part#: ATS-52400P-C1-R0

Description: 40.00 x 40.00 x 17.50 mm BGA Heat Sink - High Performance maxiFLOW w/Thermal

Tape

Heat Sink Type: maxiFLOW
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: ATS-52400P-C2-R0

## **Features & Benefits**

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- · Fabricated from extruded aluminum, which minimizes thermal resistance from the base to the fins, reduces weight and keeps costs low
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks

## **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	2 °C/W	1.6 °C/W	1.4 °C/W	1.2 °C/W	1.1 °C/W	1.1 °C/W	1 °C/W
	Ducted Flow	1.6	N/A	N/A	N/A	N/A	N/A	N/A

## **Product Detail**

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	40.00 mm	40.00 mm	17.50 mm	69.14 mm	T412	BLUE-ANODIZED
BA	<ul> <li>Dimensior</li> <li>ATS-5240         <ul> <li>(Saint-Gol</li> </ul> </li> <li>Thermal p         <ul> <li>application</li> </ul> </li> <li>ATS reser         <ul> <li>performan</li> </ul> </li> <li>ATS certifi</li> </ul>	op-C2-R0 is the example of the case of the	emponent size.  The provided for reference or change its provided for six provided for reference at each or change its provided for six provid	oly with an equivalent nce only. Actual performation ducts without notice	t thermal formance	interface material may vary by
*Image above is for illustration purpose only.						



<sup>\*</sup>Image above is for illustration purpose only.